02U/0012 A rage 1 01 4



REST AVAILABLE COPY

(11) Publication number:

62076612 A

PATENT ABSTRACTS OF JAPAN

Generated Document.

(21) Application number: 60215173

(51) Intl. Cl.: H01L 21/205 H01L 21/263

(22) Application date: 30.09.85

(30) Priority:

(43) Date of application

publication:

08.04.87

states: (84) Designated contracting

(72) Inventor: KONAGAI MAKOTO

FUKUDA NOBUHIRO KITAGAWA YORIHISA (71) Applicant: MITSUI TOATSU CHEM INC

(74) Representative:

FILM SEMICONDUCTOR THIN (54) MANUFACTURE OF

(57) Abstract:

desirably, hydrogen. consisting of fluorosilane, silane or, discomposing a mixture gas single crystalline substrate by photoa single crystalline or amorphous PURPOSE: To form a semiconductor thin film with superior orientation on

crystallineor amorphous single CONSTITUTION: A single

62076612 A Page 2 of 4

window 1, a substrate holding means which has at least a light permiating placed in a thin film forming device 7 cleaned with washing or etching is crystalline substrate whose surface is or arsine (AsH3) is usable. group compounds, phosphine (PH3) dibolane (B2H6) is usable. As V SimH2m+2 (integer of m=1W3) are usable. As the silane, monosilane, the flowing ratio of silane to is supplied to the said device, with vaccum discharge. The material gas is heated to 100W400°C under discharge means 6, and the substrate 3, a substrate heating means 4, a gas to be added to the mixture gas, usable. As the III group compounds disilane, trisilane expressed with nFn(integer of n=1W3) or Si2F6 isformer. As the fluorosilane, SiH4fluorosilane being more than twice he flowing ratio of hydrogen to the fluorosilane being 0.5W50 and the introduction means 5 and a vaccum

COPYRIGHT: (C)1987,JPO&Japio

